

# **High-speed Diode**

### DESCRIPTION

The LBAS516T1 is a high-speed switching diode fabricated in planar technology and encapsulated in the SOD523(SC79) SMD plastic package.

### FEATURES

- · Ultra small plastic SMD package
- · High switching speed: max. 4 ns
- · Continuous reverse voltage: max. 75 V
- · Repetitive peak reverse voltage: max. 85 V
- · Repetitive peak forward current: max. 500 mA.
- $\cdot$  We declare that the material of product compliance with RoHS requirements.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

### APPLICATIONS

· High-speed switching in e.g. surface mounted circuits.

### **ORDERING INFORMATION**

Device	Marking	Shipping
LBAS516T1G S-LBAS516T1G	6	3000 Tape & Reel
LBAS516T3G S-LBAS516T3G	6	10000 Tape & Reel

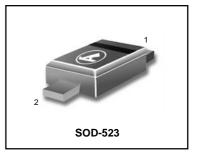
### ELECTRICAL CHARACTERISTICS T j=25°C unless otherwise specified.

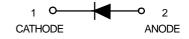
SYMBO	L PARAMETER	CONDITIONS	MAX.	UNIT
V <sub>F</sub>	forward voltage	see Fig.2 I <sub>F</sub> =1 mA	715	mV
		I <sub>F</sub> = 10 mA	855	mV
		I <sub>F</sub> =50 mA	1	V
		I <sub>F</sub> = 150 mA	1.25	V
I <sub>R</sub>	reverse current	see Fig.4 V $_{R}$ = 25 V	30	nA
		V <sub>R</sub> =75 V	1	μA
		V <sub>R</sub> = 25 V; T <sub>j</sub> = 150 °C	30	μA
		V <sub>R</sub> = 75 V; T <sub>j</sub> = 150 °C;	50	μA
C d	diode capacitance	$f = 1 \text{ MHz}; V_R = 0; \text{ see Fig.5}$	1	pF
t rr	reverse recovery time	when switched from $I_F = 10 \text{ mA to } I_R = 10 \text{ mA}$ ;	4	ns
		R $_{L}$ = 100 $\Omega$ ; measured at I $_{R}$ = 1 mA; see Fig.6		
$V_{fr}$	forward recovery voltage	when switched from $IF = 10 \text{ mA}$ ; tr = 20 ns; see Fig.7	1.75	V

#### **THERMALCHARACTERISTICS**

[	SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
	R th j-s	thermal resistance from junction to soldering point	note 1	120	K/W
Note 1. Soldering point of the cathode tab.					









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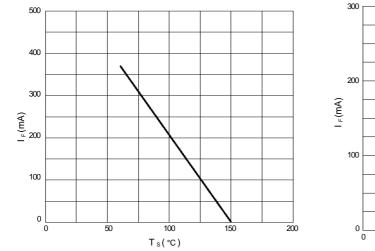
### LBAS516T1G,S-LBAS516T1G

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	repetitive peak reverse voltage		-	85	V
V <sub>R</sub>	continuous reverse voltage		—	75	V
I <sub>F</sub>	continuous forward current	T <sub>s</sub> =90°C; note 1; see Fig.1	-	250	mA
I <sub>FRM</sub>	repetitive peak forward current		-	500	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; $T_j=25^{\circ}C$ prior to			
		surge; see Fig.3			
		t =1µs	-	4	А
		t =1 ms	_	1	А
		t =1 s	-	0.5	А
P tot	total power dissipation	T <sub>s</sub> =90°C; note 1	-	500	mW
T stg	storage temperature		-65	+150	°C
T j	junction temperature		-	150	°C

### LIMITING VALUES In accordance with the Absolute Maximum Rating System (IEC 134).

Note

1. Ts is the temperature at the soldering point of the cathode tab.



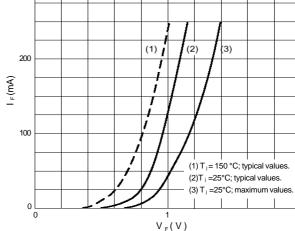


Fig.1 Maximum permissible continuous forward current as a function of soldering point temperature.

Fig.2 Forward current as a function of forward voltage.

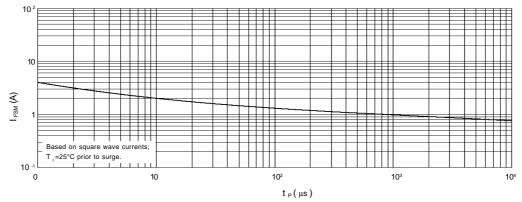


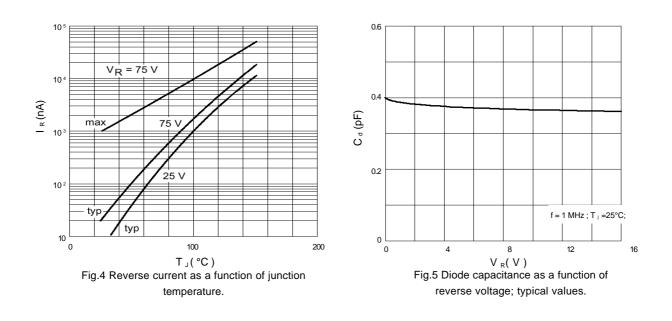
Fig.3 Maximum permissible non-repetitive peak forward current as a function of pulse duration.

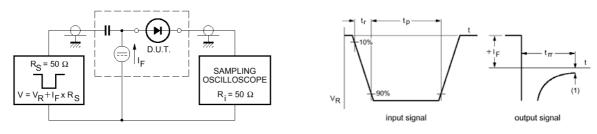
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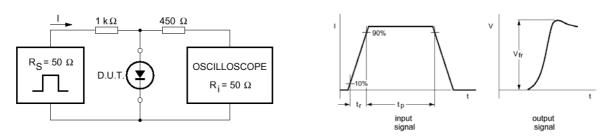
### LBAS516T1G,S-LBAS516T1G





(1) I  $_{R}$  = 1 mA. Input signal: reverse pulse rise time t  $_{r}$  = 0.6 ns; reverse voltage pulse duration t  $_{p}$  = 100 ns; duty factor  $\delta$  = 0.05; Oscilloscope: rise time t  $_{r}$  = 0.35 ns.

Fig.6 Reverse recovery voltage test circuit and waveforms.



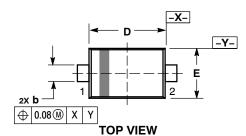
Input signal: forward pulse rise time t = 20 ns; forward current pulse duration t  $\ge$  100 ns; duty factor  $\delta \le$  0.005. Fig.7 Forward recovery voltage test circuit and waveforms.

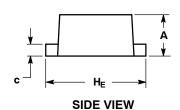


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# LBAS516T1G,S-LBAS516T1G

### SOD-523





- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PRO-TRUSIONS, OR GATE BURRS.

	MILLIMETERS		
DIM	MIN	NOM	MAX
Α	0.50	0.60	0.70
b	0.25	0.30	0.35
С	0.07	0.14	0.20
D	1.10	1.20	1.30
Е	0.70	0.80	0.90
ΗE	1.50	1.60	1.70
L	0.30 REF		
L2	0.15	0.20	0.25

RECOMMENDED **SOLDERING FOOTPRINT\*** 

